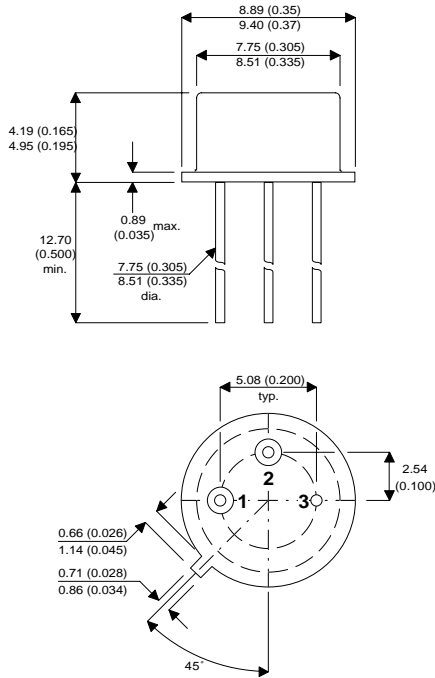


**MECHANICAL DATA**

Dimensions in mm (inches)



**TO-39 METAL PACKAGE**

**Underside View**

PIN 1 – Source                      PIN 3 – Drain  
 PIN 2 – Gate                        CASE – Drain

**N-CHANNEL  
 ENHANCEMENT MODE  
 MOS TRANSISTOR**

**FEATURES**

- Switching Regulators
- Converters
- Motor Drivers

**ABSOLUTE MAXIMUM RATINGS** ( $T_{CASE} = 25^{\circ}C$  unless otherwise stated)

$V_{DS}$	Drain – Source Voltage	35V
$V_{GS}$	Gate – Source Voltage	$\pm 20V$
$I_D$	Drain Current @ $T_{CASE} = 25^{\circ}C$	1.4A
$I_D$	Drain Current @ $T_{CASE} = 100^{\circ}C$	1A
$I_{DM}$	Pulsed Drain Current *	3A
$P_D$	Power Dissipation @ $T_{CASE} = 25^{\circ}C$	6.25W
$P_D$	Power Dissipation @ $T_{CASE} = 100^{\circ}C$	2.5W
$T_j$	Operating Junction Temperature Range	$-55$ to $150^{\circ}C$
$T_{stg}$	Storage Temperature Range	$-55$ to $150^{\circ}C$
$T_L$	Lead Temperature ( $1/16$ " from case for 10 sec.)	$300^{\circ}C$

\* Pulse width limited by maximum junction temperature.

**ELECTRICAL CHARACTERISTICS** ( $T_{CASE} = 25^{\circ}C$  unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit		
<b>STATIC CHARACTERISTICS</b>							
$V_{(BR)DSS}$	Gate – Source Breakdown Voltage	$V_{GS} = 0V$	$I_D = 10\mu A$	35	70	V	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$	$I_D = 1mA$	0.8	1.6		2
$I_{GSS}$	Gate – Body Leakage Current	$V_{GS} = \pm 15V$ $V_{DS} = 0V$	$T_{CASE} = 125^{\circ}C$			$\pm 100$ $\pm 500$	nA
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 90V$ $V_{DS} = 72V$	$V_{GS} = 0V$ $V_{GS} = 0V$ $T_{CASE} = 125^{\circ}C$			10 500	$\mu A$
$I_{D(on)*}$	On–State Drain Current	$V_{DS} = 15V$	$V_{GS} = 10V$	1.5	1.8		A
$R_{DS(on)*}$	Drain – Source On Resistance	$V_{GS} = 5V$ $V_{GS} = 10V$ $I_D = 1A$	$I_D = 0.3A$ $T_{CASE} = 125^{\circ}C$		1.8 1.3 2.6	5 1.8 3.6	$\Omega$
$V_{DS(on)*}$	Drain – Source On Voltage	$V_{GS} = 5V$ $V_{GS} = 10V$ $I_D = 1A$	$I_D = 0.3A$ $T_{CASE} = 125^{\circ}C$		0.54 1.3 2.6	1.5 1.8 3.6	V
$g_{FS*}$	Forward Transconductance	$V_{DS} = 10V$	$I_D = 0.5A$	170	350		ms
$g_{OS*}$	Common Source Output Conductance	$V_{DS} = 10V$	$I_D = 0.1A$		1100		$\mu s$
<b>DYNAMIC CHARACTERISTICS</b>							
$R_{DS(on)}$	Small Signal Drain – Source On Resistance	$V_{GS} = 10V$ $f = 1kHz$	$I_D = 1A$		1.3	1.8	$\Omega$
$C_{ds}$	Drain – Source Capacitance	$V_{DS} = 24V$ $V_{GS} = 0V$ $f = 1MHz$			30	40	pF
$C_{iss}$	Input Capacitance				35	50	
$C_{oss}$	Output Capacitance				28	40	
$C_{rss}$	Reverse Transfer Capacitance				2	10	
<b>SWITCHING CHARACTERISTICS</b>							
$t_{ON}$	Turn–On Time	$V_{DD} = 25V$ $R_L = 23\Omega$	$V_{GEN} = 10V$ $R_G = 25\Omega$		8	10	ns
$t_{OFF}$	Turn–Off Time	$I_D = 1A$			9	10	

\* Pulse Test:  $t_p \leq 80 \mu s$ ,  $\delta \leq 1\%$